Voltage Regulator - CMOS Low Dropout 300 mA

NCP114

The NCP114 is 300 mA LDO that provides the engineer with a very stable, accurate voltage with low noise suitable for space constrained, noise sensitive applications. In order to optimize performance for battery operated portable applications, the NCP114 employs the dynamic quiescent current adjustment for very low I_Q consumption at no–load.

Features

- Operating Input Voltage Range: 1.7 V to 5.5 V
- Available in Fixed Voltage Options: 0.75 V to 3.6 V Contact Factory for Other Voltage Options
- Very Low Quiescent Current of Typ. 50 μA
- Standby Current Consumption: Typ. 0.1 µA
- Low Dropout: 135 mV Typical at 300 mA
- ±1% Accuracy at Room Temperature
- High Power Supply Ripple Rejection: 75 dB at 1 kHz
- Thermal Shutdown and Current Limit Protections
- Stable with a 1 µF Ceramic Output Capacitor
- Available in UDFN and TSOP Packages
- These are Pb-Free Devices

Typical Applicaitons

- PDAs, Mobile phones, GPS, Smartphones
- Wireless Handsets, Wireless LAN, Bluetooth[®], Zigbee[®]
- Portable Medical Equipment
- Other Battery Powered Applications

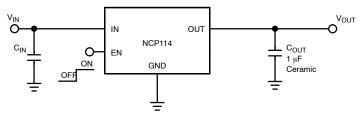
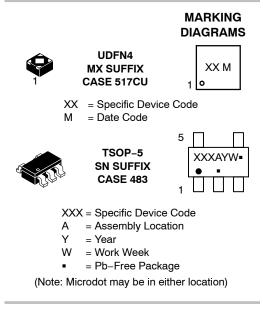


Figure 1. Typical Application Schematic

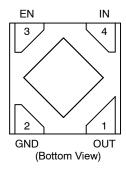


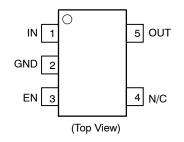
ON Semiconductor®

www.onsemi.com



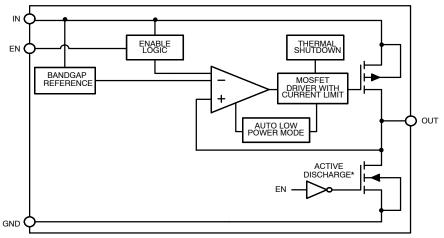






ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 15 of this data sheet.



*Active output discharge function is present only in NCP114AMXyyyTCG devices. yyy denotes the particular V_{OUT} option.

Figure 2. Simplified Schematic Block Diagram

PIN FUNCTION DESCRIPTION

Pin No. (UDFN4)	Pin No. (TSOP5)	Pin Name	Description
1	5	OUT	Regulated output voltage pin. A small ceramic capacitor with minimum value of 1 μF is needed from this pin to ground to assure stability.
2	2	GND	Power supply ground.
3	3	EN	Driving EN over 0.9 V turns on the regulator. Driving EN below 0.4 V puts the regulator into shutdown mode.
4	1	IN	Input pin. A small capacitor is needed from this pin to ground to assure stability.
-	4	N/C	Not connected. This pin can be tied to ground to improve thermal dissipation.
_	-	EPAD	Exposed pad should be connected directly to the GND pin. Soldered to a large ground copper plane allows for effective heat removal.

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Input Voltage (Note 1)	V _{IN}	–0.3 V to 6 V	V
Output Voltage	Vout	–0.3 V to VIN + 0.3 V or 6 V	V
Enable Input	VEN	–0.3 V to 6 V	V
Output Short Circuit Duration	tsc	~	s
Maximum Junction Temperature	T _{J(MAX)}	150	°C
Storage Temperature	T _{STG}	–55 to 150	°C
ESD Capability, Human Body Model (Note 2)	ESD _{HBM}	2000	V
ESD Capability, Machine Model (Note 2)	ESD _{MM}	200	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Refer to ELECTRICAL CHARACTERISTICS and APPLICATION INFORMATION for Safe Operating Area.

2. This device series incorporates ESD protection and is tested by the following methods:

ESD Human Body Model tested per EIA/JESD22-A114,

ESD Machine Model tested per EIA/JESD22-A115,

Latchup Current Maximum Rating tested per JEDEC standard: JESD78.

THERMAL CHARACTERISTICS (Note 3)

Rating	Symbol	Value	Unit
Thermal Characteristics, UDFN4 1x1 mm Thermal Resistance, Junction-to-Air	R_{\thetaJA}	170	°C/W
Thermal Characteristics, TSOP-5 Thermal Resistance, Junction-to-Air	$R_{\theta JA}$	236	°C/W

3. Single component mounted on 1 oz, FR 4 PCB with 645 mm² Cu area.

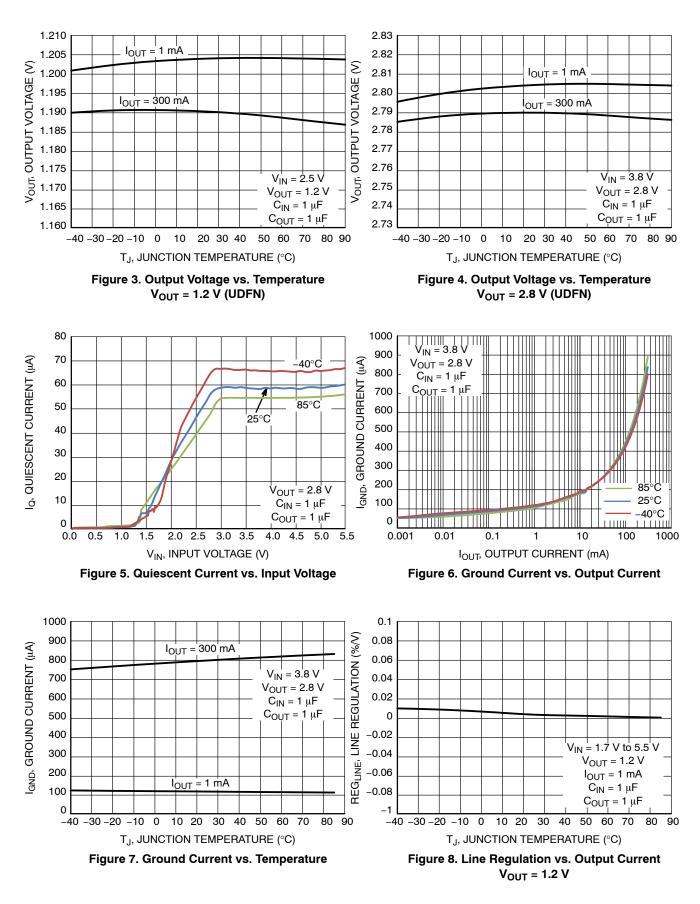
ELECTRICAL CHARACTERISTICS

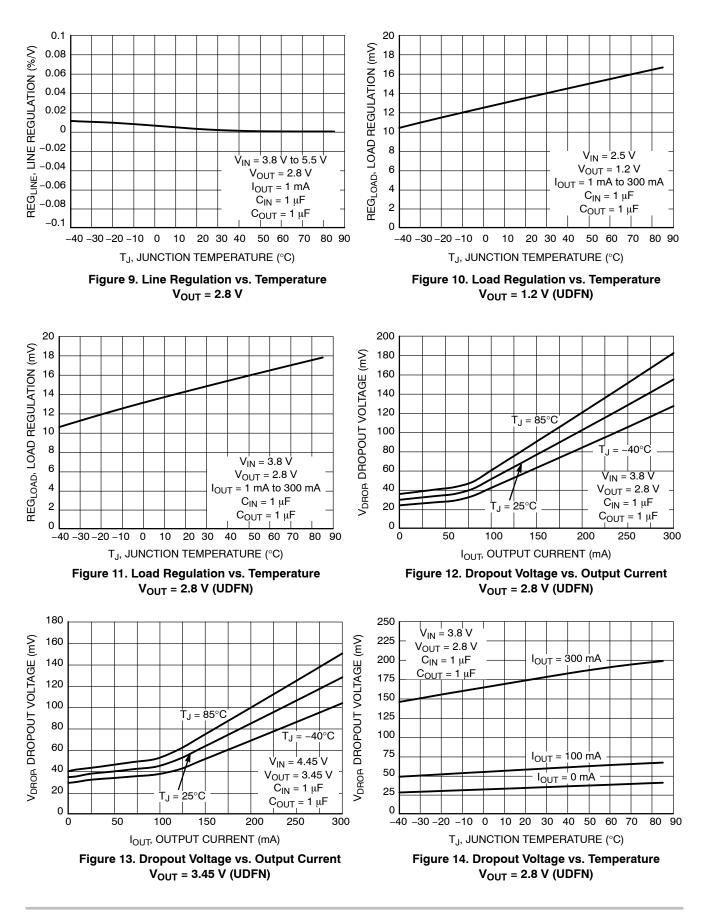
 $-40^{\circ}C \leq T_{J} \leq 85^{\circ}C; V_{IN} = V_{OUT(NOM)} + 1 \text{ V for } V_{OUT} \text{ options greater than } 1.5 \text{ V}. \text{ Otherwise } V_{IN} = 2.5 \text{ V}, \text{ whichever is greater; } I_{OUT} = 1 \text{ mA}, C_{IN} = C_{OUT} = 1 \mu\text{F}, \text{ unless otherwise noted. } V_{EN} = 0.9 \text{ V}. \text{ Typical values are at } T_{J} = +25^{\circ}C. \text{ Min./Max. are for } T_{J} = -40^{\circ}C \text{ and } T_{J} = +85^{\circ}C. \text{ Min./Max. are for } T_{J} = -40^{\circ}C \text{ and } T_{J} = +85^{\circ}C. \text{ Min./Max. are for } T_{J} = -40^{\circ}C \text{ and } T_{J} = +85^{\circ}C. \text{ Min./Max. are for } T_{J} = -40^{\circ}C \text{ and } T_{J} = +85^{\circ}C. \text{ Min./Max. are for } T_{J} = -40^{\circ}C \text{ and } T_{J} = +85^{\circ}C. \text{ Min./Max. are for } T_{J} = -40^{\circ}C \text{ and } T_{J} = +85^{\circ}C. \text{ Min./Max. are for } T_{J} = -40^{\circ}C \text{ and } T_{J} = +85^{\circ}C. \text{ Min./Max. are for } T_{J} = -40^{\circ}C \text{ and } T_{J} = -40^{\circ}C$ respectively (Note 4).

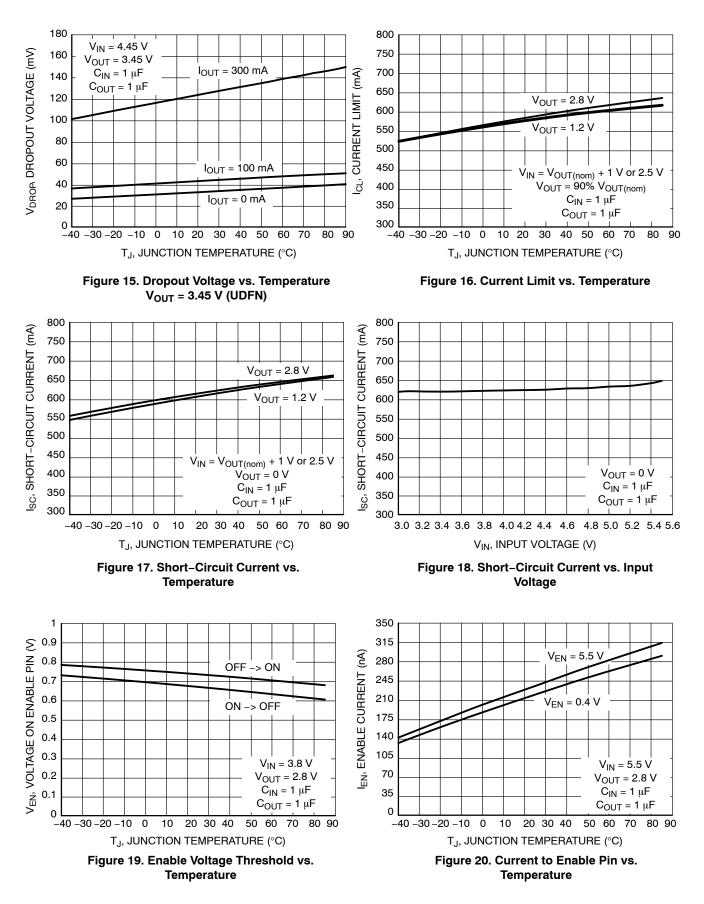
Parameter	Test Conditio	ns	Symbol	Min	Тур	Max	Unit	
Operating Input Voltage			V _{IN}	1.7		5.5	V	
		$V_{OUT} \le 2.0 \text{ V}$	V _{OUT}	-40		+40	mV	
Output Voltage Accuracy	$-40^{\circ}C \le T_J \le 85^{\circ}C$	V _{OUT} > 2.0 V		-2		+2	%	
Line Regulation	Vout + 0.5 V \leq Vin \leq 5.5 V	′ (V _{IN} ≥ 1.7 V)	Reg _{LINE}		0.01	0.1	%/V	
Load Regulation – UDFN package					12	30	mV	
Load Regulation – TSOP-5 package	IOUT = 1 mA to 30	0 mA	Reg _{LOAD}		28	45		
Load Transient	I _{OUT} = 1 mA to 300 mA or 3 in 1 μs, C _{OUT} =		Tran _{LOAD}		-50/ +30		mV	
		V _{OUT} = 1.5 V			365	460		
		V _{OUT} = 1.85 V			245	330		
		V _{OUT} = 2.8 V	.,		155	230	mV	
Dropout Voltage – UDFN package (Note 5)	l _{OUT} = 300 mA	V _{OUT} = 3.0 V	V _{DO}		145	220		
		V _{OUT} = 3.1 V			140	210		
		V _{OUT} = 3.3 V			135	200		
		V _{OUT} = 1.5 V			380	485		
		V _{OUT} = 1.85 V			260	355		
		V _{OUT} = 2.8 V			170	255		
Dropout Voltage – TSOP package (Note 5)	I _{OUT} = 300 mA	V _{OUT} = 3.0 V	V _{DO}		160	245	mV	
		V _{OUT} = 3.1 V			155	235		
		V _{OUT} = 3.3 V			150	225		
Output Current Limit	V _{OUT} = 90% V _{OU} -	Γ(nom)	I _{CL}	300	600		mA	
Ground Current	Ιουτ = 0 mA		Ι _Q		50	95	μA	
Shutdown Current	$V_{EN} \le 0.4 \text{ V}, \text{ Vin} =$	5.5 V	I _{DIS}		0.01	1	μA	
EN Pin Threshold Voltage High Threshold Low Threshold	V _{EN} Voltage incre V _{EN} Voltage decre	asing easing	V _{EN_HI} V _{EN_LO}	0.9		0.4	V	
EN Pin Input Current	VEN = 5.5 V		I _{EN}		0.3	1.0	μA	
Power Supply Rejection Ratio	$V_{IN} = 3.6 V, V_{OUT} = 3.1 V$ $I_{OUT} = 150 mA$	f = 1 kHz	PSRR		75		dB	
Output Noise Voltage	V _{IN} = 2.5 V, V _{OUT} = 1.8 V, f = 10 Hz to 100	_{OUT} = 150 mA kHz	V _N		70		μV_{rms}	
Thermal Shutdown Temperature	Temperature increasing from $T_J = +25^{\circ}C$		T _{SD}		160		°C	
Thermal Shutdown Hysteresis	Temperature falling f	rom T _{SD}	T _{SDH}		20		°C	
Active Output Discharge Resistance	VEN < 0.4 V, Versior	n A only	R _{DIS}		100		Ω	

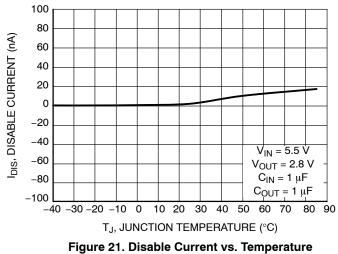
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product

4. Performance guaranteed over the indicated operating temperature range by design and/or characterization. Production tested at T_J = T_A = 25°C. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.
5. Characterized when Vout falls 100 mV below the regulated voltage at VIN = VOUT(NOM) + 1 V.

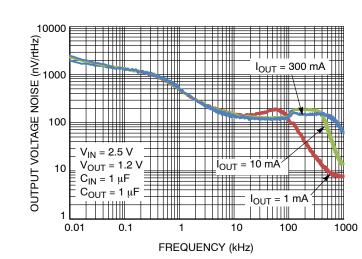






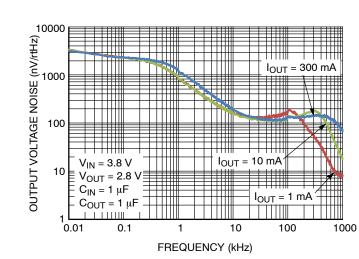






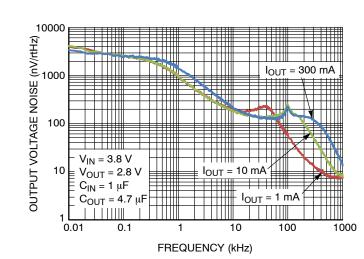
	RMS Outpu	t Noise (μV)
lout	10 Hz – 100 kHz	100 Hz – 100 kHz
1 mA	60.93	59.11
10 mA	52.73	50.63
300 mA	52.06	50.17





	RMS Outpu	t Noise (μV)
IOUT	10 Hz – 100 kHz	100 Hz – 100 kHz
1 mA	79.23	74.66
10 mA	75.03	70.37
300 mA	87.74	83.79

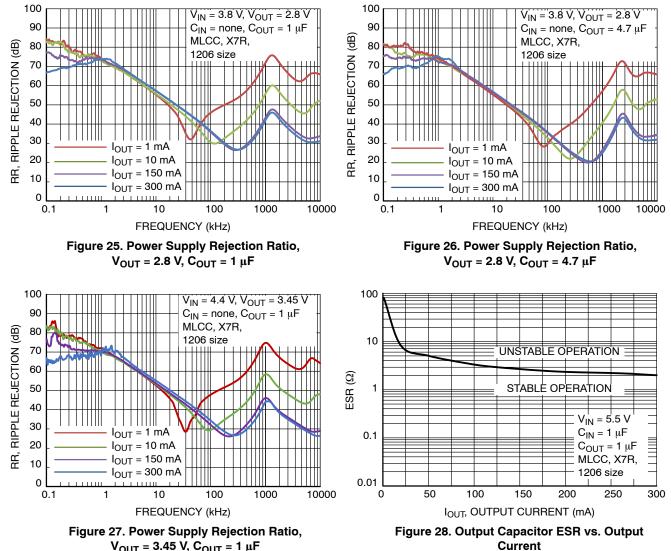
Figure 23. Output Voltage Noise Spectral Density for V_{OUT} = 2.8 V, C_{OUT} = 1 μ F



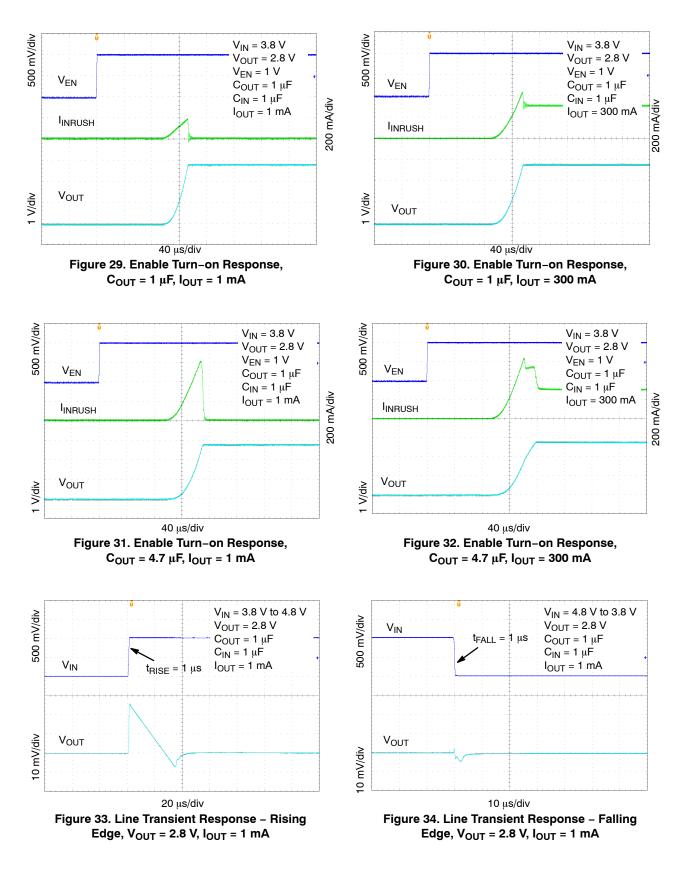
	RMS Outpu	t Noise (μV)
IOUT	10 Hz – 100 kHz	100 Hz – 100 kHz
1 mA	80.17	75.29
10 mA	81.28	76.46
300 mA	93.23	89.62

Figure 24. Output Voltage Noise Spectral Density for V_{OUT} = 2.8 V, C_{OUT} = 4.7 μ F

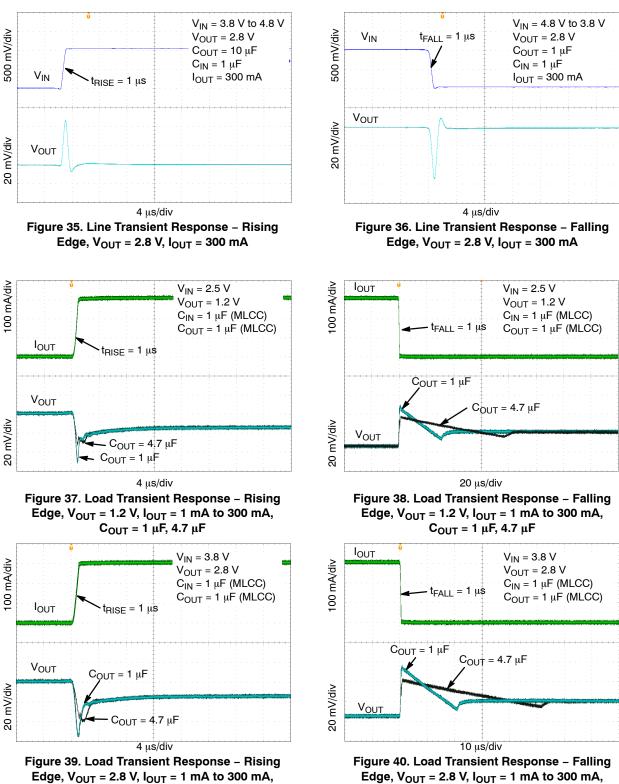
TYPICAL CHARACTERISTICS

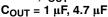


 $V_{OUT} = 3.45 V, C_{OUT} = 1 \mu F$

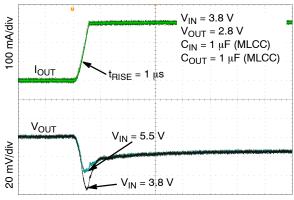


TYPICAL CHARACTERISTICS

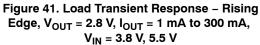


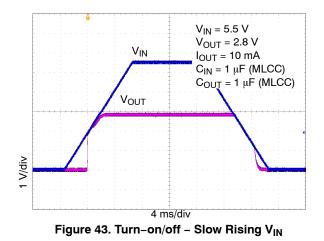


 $C_{OUT} = 1 \ \mu F, 4.7 \ \mu F$



2 μs/div





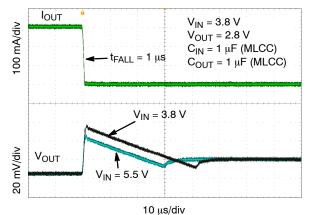


Figure 42. Load Transient Response – Falling Edge, V_{OUT} = 2.8 V, I_{OUT} = 1 mA to 300 mA, V_{IN} = 3.8 V, 5.5 V

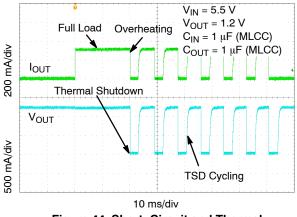


Figure 44. Short–Circuit and Thermal Shutdown

APPLICATIONS INFORMATION

General

The NCP114 is a high performance 300 mA Low Dropout Linear Regulator. This device delivers very high PSRR (over 75 dB at 1 kHz) and excellent dynamic performance as load/line transients. In connection with very low quiescent current this device is very suitable for various battery powered applications such as tablets, cellular phones, wireless and many others. The device is fully protected in case of output overload, output short circuit condition and overheating, assuring a very robust design.

Input Capacitor Selection (CIN)

It is recommended to connect at least a 1 µF Ceramic X5R or X7R capacitor as close as possible to the IN pin of the device. This capacitor will provide a low impedance path for unwanted AC signals or noise modulated onto constant input voltage. There is no requirement for the min. /max. ESR of the input capacitor but it is recommended to use ceramic capacitors for their low ESR and ESL. A good input capacitor will limit the influence of input trace inductance and source resistance during sudden load current changes. Larger input capacitor may be necessary if fast and large load transients are encountered in the application.

Output Decoupling (COUT)

The NCP114 requires an output capacitor connected as close as possible to the output pin of the regulator. The recommended capacitor value is 1 μ F and X7R or X5R dielectric due to its low capacitance variations over the specified temperature range. The NCP114 is designed to remain stable with minimum effective capacitance of 0.22 μ F to account for changes with temperature, DC bias and package size. Especially for small package size capacitors such as 0402 the effective capacitance drops rapidly with the applied DC bias.

There is no requirement for the minimum value of Equivalent Series Resistance (ESR) for the C_{OUT} but the maximum value of ESR should be less than 2 Ω . Larger output capacitors and lower ESR could improve the load transient response or high frequency PSRR. It is not recommended to use tantalum capacitors on the output due to their large ESR. The equivalent series resistance of tantalum capacitors is also strongly dependent on the temperature, increasing at low temperature.

Enable Operation

The NCP114 uses the EN pin to enable/disable its device and to deactivate/activate the active discharge function.

If the EN pin voltage is <0.4 V the device is guaranteed to be disabled. The pass transistor is turned–off so that there is virtually no current flow between the IN and OUT. The active discharge transistor is active so that the output voltage V_{OUT} is pulled to GND through a 100 Ω resistor. In the disable state the device consumes as low as typ. 10 nA from the V_{IN} .

If the EN pin voltage >0.9 V the device is guaranteed to be enabled. The NCP114 regulates the output voltage and the active discharge transistor is turned–off.

The EN pin has internal pull-down current source with typ. value of 300 nA which assures that the device is turned-off when the EN pin is not connected. In the case where the EN function isn't required the EN should be tied directly to IN.

Output Current Limit

Output Current is internally limited within the IC to a typical 600 mA. The NCP114 will source this amount of current measured with a voltage drops on the 90% of the nominal V_{OUT} . If the Output Voltage is directly shorted to ground ($V_{OUT} = 0$ V), the short circuit protection will limit the output current to 630 mA (typ). The current limit and short circuit protection will work properly over whole temperature range and also input voltage range. There is no limitation for the short circuit duration.

Thermal Shutdown

When the die temperature exceeds the Thermal Shutdown threshold (T_{SD} – 160°C typical), Thermal Shutdown event is detected and the device is disabled. The IC will remain in this state until the die temperature decreases below the Thermal Shutdown Reset threshold (T_{SDU} – 140°C typical). Once the IC temperature falls below the 140°C the LDO is enabled again. The thermal shutdown feature provides the protection from a catastrophic device failure due to accidental overheating. This protection is not intended to be used as a substitute for proper heat sinking.

Power Dissipation

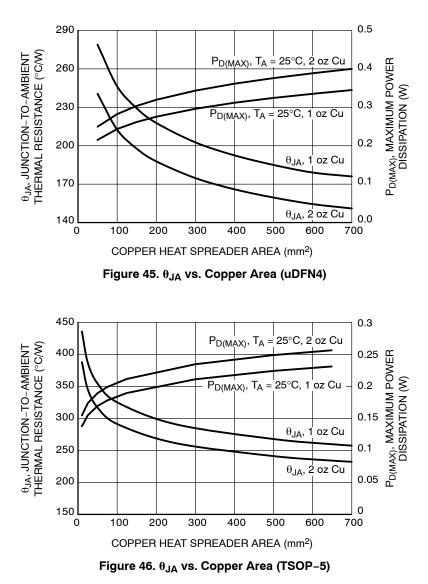
As power dissipated in the NCP114 increases, it might become necessary to provide some thermal relief. The maximum power dissipation supported by the device is dependent upon board design and layout. Mounting pad configuration on the PCB, the board material, and the ambient temperature affect the rate of junction temperature rise for the part.

The maximum power dissipation the NCP114 can handle is given by:

$$P_{D(MAX)} = \frac{\left[85^{\circ}C - T_{A}\right]}{\theta_{JA}}$$
 (eq. 1)

The power dissipated by the NCP114 for given application conditions can be calculated from the following equations:

$$\mathsf{P}_{\mathsf{D}} \approx \mathsf{V}_{\mathsf{IN}} \Big(\mathsf{I}_{\mathsf{GND}} @ \mathsf{I}_{\mathsf{OUT}} \Big) + \mathsf{I}_{\mathsf{OUT}} \Big(\mathsf{V}_{\mathsf{IN}} - \mathsf{V}_{\mathsf{OUT}} \Big) \qquad (\mathsf{eq. 2})$$



Reverse Current

The PMOS pass transistor has an inherent body diode which will be forward biased in the case that $V_{OUT} > V_{IN}$. Due to this fact in cases, where the extended reverse current condition can be anticipated the device may require additional external protection.

Power Supply Rejection Ratio

The NCP114 features very good Power Supply Rejection ratio. If desired the PSRR at higher frequencies in the range 100 kHz – 10 MHz can be tuned by the selection of C_{OUT} capacitor and proper PCB layout.

Turn-On Time

The turn–on time is defined as the time period from EN assertion to the point in which V_{OUT} will reach 98% of its

nominal value. This time is dependent on various application conditions such as $V_{OUT(NOM)}$, C_{OUT} and T_A . For example typical value for $V_{OUT} = 1.2$ V, $C_{OUT} = 1 \mu F$, $I_{OUT} = 1$ mA and $T_A = 25^{\circ}C$ is 90 μ s.

PCB Layout Recommendations

To obtain good transient performance and good regulation characteristics place C_{IN} and C_{OUT} capacitors close to the device pins and make the PCB traces wide. In order to minimize the solution size, use 0402 capacitors. Larger copper area connected to the pins will also improve the device thermal resistance. The actual power dissipation can be calculated from the equation above (Equation 2). Expose pad should be tied the shortest path to the GND pin.

ORDERING INFORMATION

Device	Voltage Option	Marking	Marking Rotation	Option	Package	Shipping [†]
NCP114AMX075TCG	0.75 V	AW	0 °			
NCP114AMX080TCG	0.80 V	AT	0°			
NCP114AMX090TAG	0.9 V	AP	0°			
NCP114AMX090TCG	0.9 V	AP	0°			
NCP114AMX092TAG	0.92 V	A2	0°			
NCP114AMX100TCG	1.0 V	6	180°			
NCP114AMX105TCG	1.05 V	R	0 °			
NCP114AMX110TBG	1.1 V	F	180°			
NCP114AMX110TCG	1.1 V	F	180°			
NCP114AMX115TCG	1.15 V	AM	0 °			
NCP114AMX120TBG	1.2 V	Т	0 °			
NCP114AMX120TCG	1.2 V	Т	0 °			
NCP114AMX125TCG	1.25 V	А	180°			
NCP114AMX130TCG	1.3 V	AA	0 °			
NCP114AMX135TCG	1.35 V	AN	0°			
NCP114AMX150TCG	1.5 V	V	0°			
NCP114AMX160TCG	1.6 V	2	180°			
NCP114AMX180TBG	1.8 V	J	180°			
NCP114AMX180TCG	1.8 V	J	180°			
NCP114AMX185TCG	1.85 V	Y	0°	With active output	UDFN4	
NCP114AMX210TCG	2.1 V	L	180°	discharge function	(Pb-Free)	3000 / Tape & Reel
NCP114AMX220TCG	2.2 V	Q	180°			
NCP114AMX240TCG	2.4 V	AH	0 °			
NCP114AMX250TBG	2.5 V	AF	0 °			
NCP114AMX250TCG	2.5 V	AF	0 °			
NCP114AMX260TCG	2.6 V	Т	180°			
NCP114AMX270TCG	2.7 V	AJ	0 °			
NCP114AMX280TBG	2.8 V	2	0°			
NCP114AMX280TCG	2.8 V	2	0°			
NCP114AMX285TCG	2.85 V	3	0 °			
NCP114AMX290TCG	2.9 V	AZ	0 °			
NCP114AMX300TCG	3.0 V	4	0 °			
NCP114AMX310TBG	3.1 V	5	0 °			
NCP114AMX310TCG	3.1 V	5	0 °			
NCP114AMX320TCG	3.2 V	AG	0 °			
NCP114AMX330TBG	3.3 V	6	0°			
NCP114AMX330TCG	3.3 V	6	0°			
NCP114AMX345TCG	3.45 V	AC	0°			
NCP114AMX350TCG	3.5 V	4	180°			
NCP114AMX360TCG	3.6 V	AU	0°			

ORDERING INFORMATION

Device	Voltage Option	Marking	Marking Rotation	Option	Package	Shipping [†]
NCP114BMX075TCG	0.75 V	CW	0°			
NCP114BMX100TCG	1.0 V	6	270°			
NCP114BMX120TCG	1.2 V	Т	90°			
NCP114BMX150TCG	1.5 V	V	90°			
NCP114BMX180TCG	1.8 V	J	270°	Without active output discharge function	UDFN4 (Pb-Free)	3000 / Tape & Reel
NCP114BMX250TCG	2.5 V	CF	0°		()	
NCP114BMX280TCG	2.8 V	2	90°			
NCP114BMX300TCG	3.0 V	4	90°	1		
NCP114BMX330TCG	3.3 V	6	90°	1		

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ORDERING INFORMATION

Device	Voltage Option	Marking	Option	Package	Shipping [†]
NCP114ASN080T1G	0.8 V	CAY			
NCP114ASN120T1G	1.2 V	CAC			
NCP114ASN120T2G					
NCP114ASN150T1G	1.5 V	CAX			
NCP114ASN150T2G					
NCP114ASN180T1G	1.8 V	CAD			
NCP114ASN180T2G					
NCP114ASN250T1G	2.5 V	CAG			
NCP114ASN250T2G			With output active discharge function	T000 -	
NCP114ASN260T1G	2.6 V	CAQ	albenarge function	TSOP–5 (Pb–Free)	3000 / Tape & Reel
NCP114ASN270T1G	2.7 V	CAV			
NCP114ASN280T1G	2.8 V	CAH			
NCP114ASN280T2G					
NCP114ASN290T1G	2.9 V	CAU			
NCP114ASN300T1G	3.0 V	CAK			
NCP114ASN330T1G	3.3 V	CAL			
NCP114ASN330T2G	┨ │				
NCP114BSN330T1G	3.3 V	CDL	Without output active discharge		

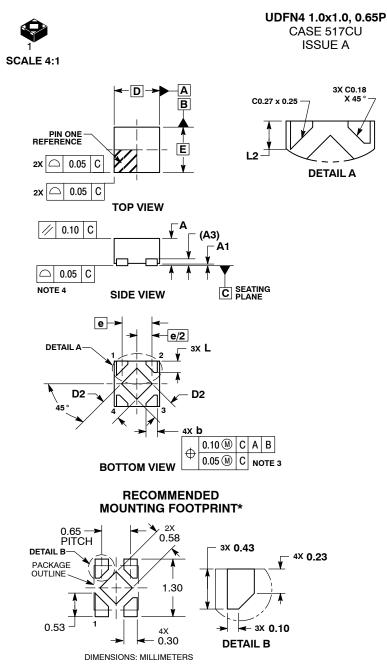
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





DOCUMENT NUMBER:	98ARB18753C	Electronic versions are uncontrolled except when accessed directly from the Printed versions are uncontrolled except when stamped "CONTROLLED 0	
DESCRIPTION:	TSOP-5		PAGE 1 OF 1
ON Semiconductor reserves the right the suitability of its products for any pa	to make changes without further notice to an articular purpose, nor does ON Semiconducto	stries, LLC dba ON Semiconductor or its subsidiaries in the United States y products herein. ON Semiconductor makes no warranty, representation r assume any liability arising out of the application or use of any product or acidental damages. ON Semiconductor does not convey any license under	or guarantee regarding circuit, and specifically





*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DATE 18 DEC 2014

NOTES:

- DIRENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.
 DIMENSION & APPLIES TO PLATED TERMINAL
- AND IS MEASURED BETWEEN 0.03 AND 0.07 FROM THE TERMINAL TIPS. COPLANARITY APPLIES TO THE EXPOSED 4 PAD AS WELL AS THE TERMINALS.

	MILLIMETERS			
DIM	MIN	MAX		
Α		0.60		
A1	0.00	0.05		
A3	0.15 REF			
b	0.20	0.30		
D	1.00	BSC		
D2	0.38	0.58		
Е	1.00	BSC		
е	0.65 BSC			
L	0.20	0.30		
L2	0.27	0.37		

GENERIC **MARKING DIAGRAM***

XX M l٥ 1

XX = Specific Device Code Μ = Date Code

*This information is generic. Please refer to device data sheet for actual part marking.

Pb-Free indicator, "G" or microdot " .", may or may not be present.

DOCUMENT NUMBER:	98AON76666F	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.			
DESCRIPTION:	UDFN4, 1.0X1.0, 0.65P		PAGE 1 OF 1		
ON Semiconductor and ()) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the					

rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and calcular performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

onsemi Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

onsemi:

NCP114AMX260TCG	NCP114AMX280TCO	MCP114AMX185TCC	MCP114AMX330TCG	NCP114AMX310TCG
NCP114AMX300TCG NO	CP114AMX110TCG	NCP114AMX150TCG	NCP114AMX100TCG	NCP114AMX130TCG
NCP114AMX180TCG NO	CP114AMX220TCG	NCP114AMX210TCG	NCP114AMX160TCG	NCP114AMX285TCG
NCP114AMX250TCG NO	CP114BMX300TCG	NCP114BMX100TCG	NCP114AMX105TCG	NCP114BMX120TCG
NCP114AMX345TCG NO	CP114BMX280TCG	NCP114AMX320TCG	NCP114BMX180TCG	NCP114AMX350TCG
NCP114AMX120TCG	CP114BMX250TCG	NCP114BMX150TCG	NCP114AMX125TCG	NCP114AMX090TCG
NCP114AMX280TBG	CP114AMX330TBG	NCP114AMX120TBG	NCP114ASN120T1G	NCP114BSN330T1G
NCP114ASN280T1G NC	CP114ASN300T1G	NCP114ASN330T1G	ICP114ASN180T1G	CP114BMX330TCG
NCP114AMX110TBG	CP114AMX180TBG	NCP114AMX075TCG	NCP114AMX360TCG	NCP114AMX135TCG
NCP114AMX270TCG	CP114AMX115TCG	NCP114AMX240TCG	NCP114AMX310TBG	NCP114AMX250TBG
NCP114ASN270T1G NC	CP114ASN290T1G	NCP114ASN150T1G	ICP114ASN080T1G	CP114ASN120T2G
NCP114ASN180T2G NC	CP114ASN250T2G	NCP114ASN150T2G	ICP114ASN280T2G	CP114ASN330T2G
NCP114AMX080TCG	CP114BMX075TCG	NCP114ASN260T1G	NCP114ASN250T1G	NCP114AMX290TCG
NCP114AMX090TAG	CP114AMX092TAG			